506863580 09/10/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6910400

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
HYOCHUL SHIN		06/24/2021
JINWOO PARK		06/24/2021
EUNHYE OH		06/24/2021
SUNGNO LEE		06/24/2021
YOUNGHYO PARK		06/24/2021
YONGKI LEE		06/24/2021
HEEJUNE LEE		06/24/2021
YOUNGJAE CHO		06/24/2021
MICHAEL CHOI		06/24/2021

RECEIVING PARTY DATA

Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU
City:	SUWON-SI, GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17471763

CORRESPONDENCE DATA

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•		e-mail address first; if that is unsuccessful, it will be sent nat is unsuccessful, it will be sent via US Mail.		
Phone:	9198	541400		
Email:	swarr	en@myersbigel.com		
Correspondent Name:	MYERS BIGEL P.A.			
Address Line 1:	4140 PARKLAKE AVE, SUITE 600			
Address Line 4:	RALEIGH, NORTH CAROLINA 27612			
ATTORNEY DOCKET NUMBE	R:	5649.5436		
NAME OF SUBMITTER:		SARA E. WARREN		

SIGNATURE:	/sew/
DATE SIGNED:	09/10/2021
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 5	
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source=5649-5436_Dec-Assign#page4	tif
source=5649-5436 Dec-Assign#page5	tif

COMBINED DECLARATION (37 CFR §1.63) FOR UTILITY PATENT APPLICATION AND ASSIGNMENT FORM¹

The undersigned acknowledges that this document is being used both as an assignment of the invention and as the declaration (37 CFR 1.63) for a Utility or Design Application.

WHEREAS, the undersigned, hereinafter referred to collectively as Assignor, has invented:

Title: SEMICONDUCTOR INTEGRATED CIRCUIT AND METHOD OF TESTING THE SAME

for which Assignor is about to make or has made United States or International application for patent.

WHEREAS, as a below named inventor(s), I/(we) hereby declare that:

Section I. Declaration

This declaration is directed to:

The The	e attac	hed U	S. noi	n-provisi	onal pate	ent applica	ation, or		
U.S				atent ap	plication			 , filed o	n
				, or					
PC1	linteri	nationa	al pate	ent appli	cation nu	imber 🚑		 , filed on	

The above-identified application was made or authorized to be made by me (us).

I (we) believe that I am (we are) the original inventor (original joint inventors) of a claimed invention in the above-identified application.

I (we) hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims.

EC Ref No.	IF-202009-020-1-US0	Attorney Ref No.	5649.5436 (CY8110US)
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SAMSUNG ELECTRONICS CO., LTD.

I acknowledge that I am aware of the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56.

Section II. Assignment

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned hereby sell(s) and assign(s) to

Samsung Electronics Co., Ltd.

having an address at **129**, **Samsung-ro**, **Yeongtong-gu**, **Suwon-si**, **Gyeonggi-do 16677**, **Republic of Korea** (hereinafter designated as the Assignee), their entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in Section I of this document.

Assignor hereby confirms any prior assignment to Assignee, and to the extent that Assignor has not already done so, agrees to assign, and hereby does, sell, assign and transfer unto Assignee and its successors in interest, their full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

Assignor hereby covenants and agrees to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

Assignor hereby covenants that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment; and

SEC Ref No.	IF-202009-020-1-US0	Attorney Ref No.	5649.5436
			(CY8110US)
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SAMSUNG ELECTRONICS CO., LTD.

Assignor hereby requests the United States Patent and Trademark Office to issue the Letters Patent of the United States of America to Assignee, and requests that any official of any country or countries foreign to the United States, whose duty it is to issue or grant patents and applications as aforesaid, to issue the Letters Patent, Utility Model Registration or other similar right to Assignee.

The undersigned hereby grant(s) the law firm of Myers Bigel, P.A. the power to insert on this Declaration and Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

Section III. Inventor(s)/Assignor(s) Signature(s)

LEGAL NAME OF	Family Name	First Given Name	Second Given Name
FIRST INVENTOR/ASSIGNOR	SHIN	HYOCHUL	
			à:
SIGNATURE	NYY		: 2. H 106/24

LEGAL NAME OF	Family Name	First Given Name	Second Given Name
SECOND	PARK	OOWAIL	
			á
	WY ws a		2021/06/24

LEGAL NAME OF	Family Name	First Given Name	Second Given Name
THIRD	ОН	EUNHYE	
SIGNATURE	<u>1</u> .2m	DATE	2.08 16124
		······ 22	

SEC Ref No.	IF-202009-020-1-US0	Attorney Ref No.	5649.5436
		n daalah na baga gara ka sa baran na sa	(CY8110US)

COMBINED DECLARATION (37 CFR 1.63) FOR UTILITY PATENT APPLICATION AND ASSIGNMENT FORM Page 3 of 5

LEGAL NAME OF FOURTH INVENTOR/ASSIGNOR	Family Name LEE	First Given Name SUNGNO	Second Given Name
SIGNATURE	Surgno (ce	DATE	21.6.2.6

LEGAL NAME OF FIFTH INVENTOR/ASSIGNOR	Family Name PARK	First Given Name YOUNGHYO	Second Given Name	
SIGNATURE	ist ors te	DATE	21.6.24	

LEGAL NAME OF	Family Name	First Given Name	Second Given Name
SIXTH INVENTOR/ASSIGNOR	LEE IF 2015 Hebundsy),	YONGKI 신요 12/16005919	
SIGNATURE	Jale-	DATE	21.6.2×
		-	

LEGAL NAME OF SEVENTH		Family Name	First Given Name	Second Given Name
INVENTOR/ASSI	1	LEE	HEEJUNE	
SIGNA	ATURE	Heepsive Lex	DATE	2.1. 6. 24
SEC Ref No.	(F-20	02009-020-1-USO	Attorney Ref No.	5649.5436 (CY8110U5)

COMBINED DECLARATION (37 CFR 1.63) FOR UTILITY PATENT APPLICATION AND ASSIGNMENT FORM Page 4 of 5

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SAMSUNG ELECTRONICS CO., LTD.

LEGAL NAME OF	Family Name	First Given Name	Second Given Name
EIGHTH INVENTOR/ASSIGNOR	СНО	YOUNGJAE	
SIGNATURE	<u>/E/E/J</u> &~~	DATE	2.4. Juny, 2021

LEGAL NAME OF NINETH INVENTOR/ASSIGNOR	Family Name	First Given Name	Second Given Name
	СНОІ	MICHAEL	
SIGNATURE	Michael	Chron DATE	June 24th, 2021

1P2#會型(Foundry)/社会型/16009919

			***************************************	00000
SEC Ref No.	IF-202009-020-1-US0	Attorney Ref No.	5649.5436	
			(CY8110US)	

COMBINED DECLARATION (37 CFR 1.63) FOR UTILITY PATENT APPLICATION AND ASSIGNMENT FORM Page 5 of 5

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